



Product Change Notification

Change Notification #: 117146 - 00
Change Title: Intel® Integrated RAID Module
RMS3CC080
Intel® Integrated RAID Module
RMS3CC040
PCN 117146-00, Product Design, Label,
Order Code
Voltage Regulator Change, Label
Update, and New Order Code
Date of Publication: September 5, 2019

Key Characteristics of the Change:

Product Design, Label, Order Code

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	September 19, 2019
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Integrated RAID Module RMS3CC080 and the Intel® Integrated RAID Module RMS3CC040:

- 1) Change internal voltage regulator due to the end of life of the previous one.
- 2) Add a label for Korea certification.
- 3) The Order Code will be changing.

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from this change.

Product with these changes will have a new Order Code (MM#).

Products Affected / Intel Ordering Codes:

Product Code	Pre Change MM#	Pre Change TA	Pre Change PBA	Post Change MM#	Post Change TA	Post Change PBA
RMS3CC040	932473	H17953-006	H24095-303	999L39	H17953-007	H24095-304
RMS3CC080	932474	H17954-006	H24096-303	999L36	H17954-007	H24096-304

PCN Revision History:

Date of Revision:
September 5, 2019

Revision Number:
00

Reason:
Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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